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- Author(s): Rauch, Christian & Tuomisto, Filip & Vilalta-Clemente, Arantxa & Lacroix, Bertrand & Ruterana, Pierre & Kraeusel, Simon & Hourahine, Ben & Schaff, William J.
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## Defect evolution and interplay in n-type InN

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## Defect evolution and interplay in n-type InN

Christian Rauch,<sup>1,a)</sup> Filip Tuomisto,<sup>1</sup> Arantxa Vilalta-Clemente,<sup>2</sup> Bertrand Lacroix,<sup>2</sup> Pierre Ruterana,<sup>2</sup> Simon Kraeusel,<sup>3</sup> Ben Hourahine,<sup>3</sup> and William J. Schaff<sup>4</sup> <sup>1</sup>Department of Applied Physics, Aalto University, P.O. Box 11100, FI-00076 Aalto, Espoo, Finland <sup>2</sup>CIMAP, UMR 6252 CNRS-ENSICAEN-CEA-UCBN, 6, Boulevard du Maréchal Juin, 14050 Caen Cedex, France

<sup>3</sup>Department of Physics, SUPA, Strathclyde University, G4 0NG Glasgow, United Kingdom <sup>4</sup>Department of Electrical and Computer Engineering, Cornell University, 425 Philips Hall, Ithaca, New York 14853, USA

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The nature and interplay of intrinsic point and extended defects in n-type Si-doped InN epilayers with free carrier concentrations up to  $6.6 \times 10^{20}$  cm<sup>-3</sup> are studied using positron annihilation spectroscopy and transmission electron microscopy and compared to results from undoped irradiated films. In as-grown Si-doped samples, mixed In-N vacancy complexes ( $V_{\rm In}$ - $V_{\rm N}$ ) are the dominant III-sublattice related vacancy defects. An increase in the number of  $V_{\rm N}$  in these complexes toward the interface suggests high concentrations of additional isolated  $V_{\rm N}$  and  $V_{\rm N}$ -clusters near the GaN buffer layer and coincides with elevated dislocation densities in that area. © 2012 American Institute of Physics. [doi:10.1063/1.3688038]

InN possesses a strong propensity for n-type conductivity which can be explained by an exceptionally high Fermi stabilization energy<sup>1</sup> well above the conduction band minimum. Taming the conductivity is one requirement for exploiting the material's high potential for electronic and opto-electronic devices.<sup>2</sup> Therefore, a deep understanding of the defect landscape in n-type InN is required. Ab-initio calculations predict that hydrogen acts as an effective donor impurity in InN,<sup>3</sup> while  $V_{\rm N}$  and  $V_{\rm In}$  should be the dominant intrinsic donor and acceptor type point defects.<sup>4</sup> Additionally, high densities of extended defects are commonly found in as-grown material and have been correlated with an electron accumulation layer at InN interfaces.<sup>5</sup> In this letter, we use positron annihilation spectroscopy (PAS) and transmission electron microscopy (TEM) to study the evolution and interplay of native point and extended defects in highly ntype InN under different conditions. Si-doped InN layers<sup>7</sup> with free electron concentrations from  $4.5 \times 10^{19}$  to  $6.6 \times$  $10^{20}$  cm<sup>-3</sup> are investigated and compared to results from an undoped ( $n_e = 1 \times 10^{18} \text{ cm}^{-3}$  before irradiation) irradiated InN film<sup>6</sup> before (3.2 × 10<sup>20</sup> cm<sup>-3</sup>) and after annealing  $(6 \times 10^{19} \text{ cm}^{-3})$ . The undoped sample was irradiated at room temperature with 2 MeV <sup>4</sup>He<sup>+</sup> ions at a fluence of  $8.9 \times 10^{15}$  cm<sup>-2</sup> and subsequently rapid-thermal-annealed (RTA) at 475 °C.<sup>6</sup> All films were deposited by plasmaassisted molecular beam epitaxy (PAMBE) as ~500 nm thick layers on c-plane sapphire substrates with a GaN buffer layer.6,7

TEM measurements of thin cross-sectional samples were performed using a JEOL 2010 operating at an acceleration voltage of 200 kV.<sup>8</sup> Fig. 1 shows a TEM micrograph obtained in weak beam (WB) conditions with g = 11-20 for a representative Si-doped sample. Edge and mixed type dislocations are visible distributed throughout the InN layer with an average density of  $4.0 \times 10^9$  cm<sup>-2</sup> and  $1.1 \times 10^9$ 

cm<sup>-2</sup>, respectively. An agglomeration of dislocations close to the InN/GaN interface can be noticed. The density of screw type dislocations is  $3.1 \times 10^8$  cm<sup>-2</sup> which corresponds to ~6% of the total dislocation density. Additionally, a high density ( $3 \times 10^5$  cm<sup>-1</sup>) of stacking faults was revealed for WB conditions<sup>8</sup> with g = 10–10 (not shown here). In the irradiated InN film, earlier TEM results<sup>9</sup> showed irradiationinduced formation dislocation loops in addition to a significant density of planar defects introduced during growth. After annealing at 475 °C, the density of dislocation loops increased from 2.2 × 10<sup>10</sup> cm<sup>-2</sup> to 9.0 × 10<sup>10</sup> cm<sup>-2</sup>.<sup>6,9</sup> Vacancy agglomeration after annealing was proposed as reason for this increase.

We applied PAS to investigate vacancy-type point defects and their nature in the InN samples. Using a monoenergetic positron beam, depth-dependent Doppler broadening spectra were recorded at room temperature to probe the momentum distribution of annihilating electron-positron pairs. Details on the experimental technique and setup can be found elsewhere.<sup>10,11</sup>

Fig. 2(a) shows the measured S-parameters of a representative Si-doped sample for positron implantation energies from 0 to 20 keV. After annihilation at surface-specific states



FIG. 1. Cross-sectional dark-field TEM micrograph (g = 11–20) of a representative Si-doped sample ( $n_e = 4.0 \times 10^{20} \text{ cm}^{-3}$ ), showing edge and mixed type dislocations.



FIG. 2. (Color online) Measured S parameter (open circles) of sample 2 as a function of the mean positron implantation depth (a). Corresponding implantation energies are given for comparison. The solid line shows a fit of the data using a simple three-layer model of the S-parameter (dashed line). (b) shows the calculated positron implantation profiles and fractions for positron implantation energies of 6 keV (I) and 12 keV (II).

for low implantation energies, the S-parameter drops quickly to a local minimum at  $\sim$ 6 keV. Comparison with the positron implantation profile at that energy [Fig. 2(b)] reveals that this point is representative for annihilations from the first 150 nm of the sample, with a mean implantation depth of  $\bar{x} = 100 \,\mathrm{nm}$ . Deeper inside the sample, the S-parameter increases to a local maximum at ~12 keV (corresponding to a mean implantation depth of  $\bar{x} = 310 \text{ nm}$ ) and positrons probe a wide region reaching the interface to the GaN buffer layer. For higher implantation energies, a significant amount of positrons annihilate in the GaN buffer layer pulling the measured S-parameter towards the value of the GaN lattice. The solid curve in Fig. 2(a) shows a fit of the measured spectrum using the multi-layer fitting program VEPFIT.<sup>12</sup> It reveals that the experimental spectrum can be well described assuming a two-layer structure of the S-parameter inside the InN film (see dashed line) with a 300 nm thick near-surface and 200 nm thick near-interface layer and a positron diffusion length of  $\sim 5$  nm.

Representative for the near-surface ("layer") and nearinterface ("interface") areas, the measured S and W parameter at 6 and 12 keV are plotted in Fig. 3 together with accordingly determined values of the remaining samples. All points are normalized by the value of an InN reference sample for which no positron trapping at open volume defects is observed.<sup>11</sup> Samples 1 and 5 a did not exhibit any depthprofile, and therefore, only one set of parameters is displayed. For all Si-doped samples (samples 1-4), the "layer" points fall on one line through the reference value of the InN lattice. Hence,<sup>10</sup> one dominant vacancy-type positron trap is present in this area with increasing (room-temperature) annihilation fraction from samples 1 to 4. When approaching the interface, an increasing (decreasing) S (W) parameter is visible for samples 2-4. This leads to a deviation of the "interface" points from the "layer" line and indicates a



FIG. 3. (Color online) SW plot of the measured line-shape parameters representative for the near-surface ("layer," filled symbols) and near-interface ("interface," black border) areas of the InN samples. Different symbols are used for different samples. Si-doped samples are depicted in blue (light color) and irradiated in black (dark color). All parameters are normalized by a suitable reference for the InN lattice.

change in the identity of the dominant vacancy-type positron trap near the interface. The slope defined by the irradiated sample before annealing (sample 5 a) is steeper<sup>13</sup> than for the as-grown samples. Upon rapid thermal annealing<sup>6</sup> (sample 5 b), a profile in the depth dependent spectrum of the Sparameter is developed<sup>14</sup> with a layer and interface-specific value. The near-surface "layer"-point is shifted closer toward the InN lattice point but remains on the same line as the asirradiated sample. This indicates a decrease in annihilation fraction at the same positron trap as before annealing. The "interface" point, however, deviates strongly after annealing and is moved close to the interface points of the Si-doped samples which signals a change of the identity of the nearinterface positron trap similar to the Si-doped case.

We find 3 different dominant vacancy-type positron traps in the InN samples, i.e., defects created by high-energy particle irradiation (i), defects dominant at the near-surface area of as-grown Si-doped samples (ii), and defects responsible for the observed changes at the interfaces of both Sidoped as well as RTA-treated, irradiated samples (iii). A comparison of high-resolution coincidence Doppler broadening spectra with density functional theory (DFT) calculations of positron trapping and annihilation in InN reveals<sup>11</sup> that these positron traps can be identified as (i) isolated In vacancies (V<sub>In</sub>), (ii) mixed In-N divacancies (V<sub>In</sub>-V<sub>N</sub>), and (iii) bigger  $V_{\text{In}}$ - $mV_{\text{N}}$  ( $m \approx 2, 3$ ) vacancy complexes, respectively. High-energy particle irradiation introduces isolated  $V_{\text{In}}$  as dominant vacancy-type positron traps in InN. Subsequent annealing leads to a re-arrangement of vacancy defects,<sup>14</sup> as observable in both TEM and positron annihilation measurements. V<sub>In</sub> become mobile at or below the annealing temperature and start to move toward the surface and the interface with the GaN buffer, respectively, where they either recombine, anneal out (at the surface), or form complexes with residual  $V_{\rm N}$  (interface). Based on the employed annealing temperature of 475 °C, we can estimate<sup>15</sup> an upper limit of  $E_b \leq 1.9$  eV for the migration barrier of the  $V_{\text{In}}$ . This is in good agreement with the calculated value of 1.6 eV (Ref. 16) and indicates that isolated  $V_{\text{In}}$  are mobile during InN growth (assuming usual growth temperatures of, e.g., ~550 °C in MBE).

No isolated V<sub>In</sub> are observed in our measurements of asgrown Si-doped InN. Instead, we find  $V_{\text{In}}$ - $V_{\text{N}}$  complexes. Hence, we conclude that in-grown  $V_{\text{In}}$  are stabilized through the formation of complexes with  $V_{\rm N}$ . This is supported by recent DFT results<sup>16</sup> which predict a positive binding energy between V<sub>In</sub> and V<sub>N</sub>. Vacancy-stabilization through the formation of vacancy-donor complexes has been observed also in GaN (Ref. 17 and references therein) and AlN.<sup>18</sup> The increased incorporation of  $V_{\text{In}}$  complexes with increasing free electron concentration suggests strongly that V<sub>In</sub>-related defects act as a source of compensation in n-type InN, which is in line with theoretical results.<sup>4</sup> The enhanced formation of larger  $V_{\text{In}}$ -m $V_{\text{N}}$  complexes toward the interface with the GaN buffer layer (in irradiated material after annealing as well as Si-doped samples) indicates that the InN/GaN interface is attractive for vacancy defects. An additional high density of  $V_{\rm N}$  in that area could provide the proximity required for the promotion of efficient vacancy  $V_{\text{In}}$ -m $V_{\text{N}}$ clustering. However, neutral and positively charged isolated  $V_{\rm N}$  and  $mV_{\rm N}$ -complexes cannot be detected in PAS measurements.<sup>11</sup> Duan and Stampfl<sup>19</sup> have calculated a positive binding energy between isolated  $V_{\rm N}$  under n-type conditions and a strong tendency for the formation of larger  $V_{\rm N}$  clusters. Hence, the formation of  $V_{\text{In}}$ -m $V_{\text{N}}$  complexes could occur through a precursor state of  $mV_{\rm N} + V_{\rm In} \rightarrow V_{\rm In}$ -mV<sub>N</sub>, in accordance to what has been proposed earlier in Mg-doped  $InN.^{20}$ 

Based on the TEM data, the observed increase in vacancy clustering at the InN/Gan interface coincides with elevated dislocation densities in that area. In order to assess the effect of dislocations on the formation energies of point defects in their vicinity, we performed DFT calculations of strained InN lattices. We found that typical strain associated with screw dislocations (0%-15% shear) decreases the formation energies of  $V_{\text{In}}$  and  $V_{\text{N}}$  only slightly by  $\leq 30 \text{ meV}$ and, hence, should not play any major role. Investigations on the effects of edge dislocations are under way. Besides strain-related influences on the defect formation energies, additional dislocation-related vacancy formation mechanisms such as dislocation movement and/or decoration of dislocations might be possible. In GaN, recent theoretical calculations<sup>21</sup> suggest stable configurations of vacancies inside dislocation cores, and a correlation between vacancy densities and dislocations was found.<sup>22</sup> It should be noted that dislocations might also directly affect the positron annihilation signal<sup>23</sup> by forming shallow traps for positrons. The exceptionally low values of the positron diffusion length in the InN samples do support the presence of such additional positron trapping centers with annihilation characteristics close to the bulk. Detailed theoretical investigations on positron trapping and annihilation at dislocations in wurtzite semiconductors are currently being performed.

and anneal out at temperatures of  $\leq$  475 °C if not stabilized by other point defects. Stabilization of  $V_{\text{In}}$  occurs through complex formation with  $V_{\text{N}}$ .  $V_{\text{In}}$ - $mV_{\text{N}}$  complexes are the dominant vacancy-type positron trap in as-grown InN samples. Toward the interface between the InN layer and the GaN buffer, enhanced formation of bigger vacancy clusters with increasing number of  $V_{\text{N}}$  is observed in both as-grown and irradiated material after annealing and coincides with increased dislocation densities in that area. This indicates that the InN/GaN interface is strongly attractive for vacancy defects and points at elevated concentrations of additional  $V_{\text{N}}$  and  $V_{\text{N}}$ -complexes in that area.

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In summary, combining results from PAS and TEM, we find that isolated  $V_{\text{In}}$  are only present in irradiated InN films